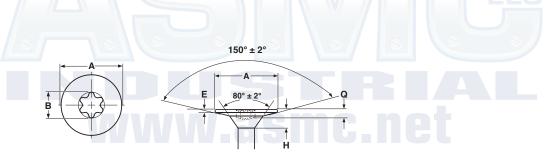
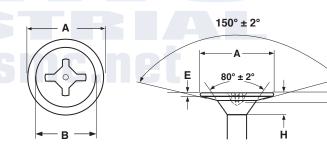
Wafer: Six-Lobe & Combo Square-Phillips

HEAD DIMENSIONS



WAFER SIX-LOBE HEAD FOR SELF-DRILLING SCREWS												
	А		В	н	w							
Nominal Size	Head D	iameter	Recess Diameter	Total Head Height	Wafer Thickness		Six-Lobe Recess Size					
	Max.	Min.	Ref	Мах	Max	Min						
10	.516	.441	.155	.095	.039	.031	3					

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur



	WAFER	SQUARE	-PHILLIPS C	омво Неа	d for Self	-DRILLING	SCREWS	
	A Head Diameter		B Recess Penetration Depth		н	W Wafer Thickness		Six-Lobe Recess Size
Nominal Size					Total Head Height			
Γ	Max.	Min.	Max.	Min.	Max	Мах	Min	
10	.515	.440	.076	.064	.157	.040	.030	3